# Monolithic Dual Switching Diode Common Cathode

## **Features**

 These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

## **MAXIMUM RATINGS (EACH DIODE)**

Rating	Symbol	Value	Unit
Reverse Voltage	$V_R$	70	Vdc
Forward Current	Ιϝ	200	mAdc
Peak Forward Surge Current	I <sub>FM(surge)</sub>	500	mAdc

## THERMAL CHARACTERISTICS

Characteristic (One Junction Heated)	Symbol	Max	Unit
Total Device Dissipation, T <sub>A</sub> = 25°C	P <sub>D</sub>	357 (Note 1)	mW
Derate above 25°C		2.9 (Note 1)	mW/°C
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	350 (Note 1)	°C/W
Characteristic			
(Both Junctions Heated)	Symbol	Max	Unit
Total Device Dissipation, T <sub>A</sub> = 25°C	P <sub>D</sub>	500 (Note 1)	mW
Derate above 25°C		4.0 (Note 1)	mW/°C
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	250 (Note 1)	°C/W
Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C

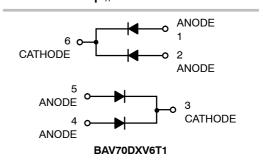
Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. FR-4 @ Minimum Pad



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SOT-563 CASE 463A PLASTIC

## **MARKING DIAGRAM**



A4 = Specific Device Code

M = Month Code

= Pb-Free Package

(Note: Microdot may be in either location)

## **ORDERING INFORMATION**

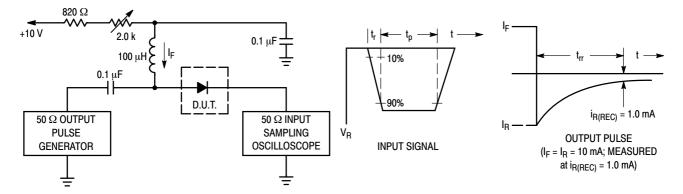
Device	Package	Shipping <sup>†</sup>
BAV70DXV6T5G	SOT-563 (Pb-Free)	8000/Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

## ELECTRICAL CHARACTERISTICS (T<sub>A</sub> = 25°C unless otherwise noted) (EACH DIODE)

Characteristic		Symbol	Min	Max	Unit
OFF CHARACTERISTICS			•	•	
Reverse Breakdown Voltage (Note 2) (I <sub>(BR)</sub> = 100 μAdc)		V <sub>(BR)</sub>	70	_	Vdc
Reverse Voltage Leakage Current (Note 2) $ \begin{array}{l} (V_R = 25 \ \text{Vdc}, T_J = 150^{\circ}\text{C}) \\ (V_R = 70 \ \text{Vdc}) \\ (V_R = 70 \ \text{Vdc}, T_J = 150^{\circ}\text{C}) \end{array} $		I <sub>R</sub>	- - -	60 2.5 100	μAdc
Diode Capacitance (Note 2) (V <sub>R</sub> = 0, f = 1.0 MHz)		C <sub>D</sub>	_	1.5	pF
Forward Voltage (Note 2) (I <sub>F</sub> = 1.0 mAdc) (I <sub>F</sub> = 10 mAdc) (I <sub>F</sub> = 50 mAdc) (I <sub>F</sub> = 150 mAdc)		V <sub>F</sub>	- - - -	715 855 1000 1250	mVdc
Reverse Recovery Time (Note 2) $(I_F = I_R = 10 \text{ mAdc}, V_R = 5.0 \text{ Vdc}, I_{R(REC)} = 1.0 \text{ mAdc})$ (Figure 1)	R <sub>L</sub> = 100 Ω	t <sub>rr</sub>	_	6.0	ns

<sup>2.</sup> For each individual diode while second diode is unbiased.



Notes: 1. A 2.0  $k\Omega$  variable resistor adjusted for a Forward Current (IF) of 10 mA.

- 2. Input pulse is adjusted so I<sub>R(peak)</sub> is equal to 10 mA.
- 3.  $t_p \gg t_{rr}$

Figure 1. Recovery Time Equivalent Test Circuit

## **Curves Applicable to Each Anode**

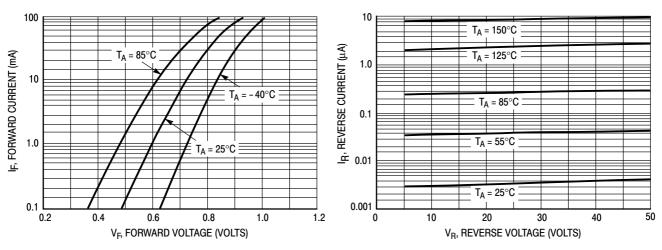


Figure 2. Forward Voltage

Figure 3. Leakage Current

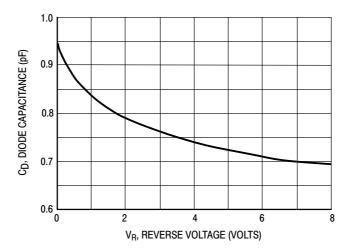
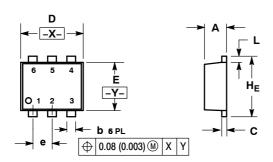


Figure 4. Capacitance

#### PACKAGE DIMENSIONS

## SOT-563, 6 LEAD CASE 463A ISSUE F

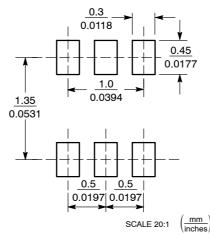


#### NOTES:

- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- 2. CONTROLLING DIMENSION: MILLIMETERS
- 2. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL.

	MILLIMETERS			INCHES		
DIM	MIN	NOM	MAX	MIN	NOM	MAX
Α	0.50	0.55	0.60	0.020	0.021	0.023
b	0.17	0.22	0.27	0.007	0.009	0.011
C	0.08	0.12	0.18	0.003	0.005	0.007
D	1.50	1.60	1.70	0.059	0.062	0.066
Е	1.10	1.20	1.30	0.043	0.047	0.051
е	0.5 BSC			C	0.02 BS0	
L	0.10	0.20	0.30	0.004	0.008	0.012
HE	1.50	1.60	1.70	0.059	0.062	0.066

#### **SOLDERING FOOTPRINT\***



\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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